

RX Family

R01AN5824EJ0105 Rev.1.05 Aug.10.22

Firmware Update Module Using Firmware Integration Technology

Introduction

This application note describes the firmware update module using Firmware Integration Technology (FIT). The module is referred to below as the firmware update FIT module.

This application note is based on Renesas MCU Firmware Update Design Policy (R01AN5548). It is recommended that the reader read that document before consulting this application note.

By using the FIT module, users can easily incorporate firmware update functionality into their applications. This application note explains how to use the firmware update FIT module and how to incorporate its API functions into user applications.

Target Devices

RX130 Group

RX140 Group

RX230, RX231, RX23E-A, RX23W Group

RX65N, RX651 Group

RX66N Group

RX66T Group

RX660 Group

RX671 Group

RX72M Group

RX72N Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

Related Application Notes

Application notes related to this application note are listed below. Refer to them in conjunction with this application note.

- Renesas MCU Firmware Update Design Policy (R01AN5548)
- RX Family How to implement FreeRTOS OTA by using Amazon Web Services on RX65N (R01AN5549)
- Firmware Integration Technology User's Manual (R01AN1833)
- RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)
- RX Smart Configurator User's Guide: IAREW (R20AN0535)
- RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)
- RX Family Flash Module Using Firmware Integration Technology (R01AN2184)
- RX Family SCI Module Using Firmware Integration Technology (R01AN1815)
- RX Family Ethernet Module Using Firmware Integration Technology (R01AN2009)
- RX Family CMT Module Using Firmware Integration Technology (R01AN1856)
- RX Family BYTEQ Module Using Firmware Integration Technology (R01AN1683)
- RX Family System Timer Module Firmware Integration Technology (R20AN0431)



Target Compilers

- C/C++ Compiler Package for RX Family from Renesas Electronics
- GCC for Renesas RX
- IAR C/C++ Compiler for RX

For compiler details related to the environment on which operation has been confirmed, refer to 5.1, Confirmed Operation Environment.

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1. Overview

1.1 About the Firmware Update Module

A firmware update is a process in which the firmware, the software that controls the device's hardware, is overwritten with a new version of the firmware. Firmware updates may be applied to fix bugs, add new functions, or improve performance.

On RX Family MCUs the firmware is written (programmed) to the on-chip flash memory. Therefore, in the case of the RX Family, the term firmware update refers to the operations and processing for overwriting the contents of the MCU's on-chip flash memory.

Generally, one of the following two methods is used to overwrite the contents of the MCU's on-chip flash memory.

- Off-board programming
 A method in which the MCU is connected to an external flash programming device such as a PC running
 Flash Programmer and the flash memory is overwritten
- On-board programming (self-programming)
 A method in which the MCU is made to overwrite its own on-chip flash memory

The latter self-programming function is used for firmware updates; the MCU programs its own on-chip flash memory.

To perform self-programming of the on-chip flash memory, it is necessary first to copy to the RAM the program that will program the flash memory and then to execute flash memory programming commands from the RAM. Since users need to obtain new firmware versions via a variety of interfaces, it used to be very difficult to build firmware update functionality into the customer's system.

However, using the firmware update FIT module makes it easy to integrate firmware update functionality into the customer's system.

The firmware update module can be incorporated into user projects as an API. For instructions on adding the module, refer to 2.10, Adding the FIT Module to Your Project.



1.2 Configuration of Firmware Update Module

The firmware update module is middleware for the purpose of updating the firmware of the MCU.

The firmware update module has functions for use on OS-less systems and functions for use on systems using FreeRTOS over-the-air (OTA) updates. For details of FreeRTOS over-the-air (OTA) updates, refer to the following webpage:

https://docs.aws.amazon.com/freertos/latest/userguide/freertos-ota-dev.html

Figure 1.1 shows a system configuration incorporating the firmware update module on an OS-less system, and Figure 1.2 shows a system configuration incorporating the firmware update module on a system using FreeRTOS over-the-air (OTA) updates.

The bootloader module runs first after the system is reset and verifies that the user program (the program that runs after the bootloader) has not been tampered with.

The firmware update module is incorporated into the user program and performs the actual firmware update.

Table 1.1 lists the FIT modules used for firmware updates.

The firmware to be applied as an update is received via a communication interface and then programmed to the code flash memory of the target device via the firmware update module and flash FIT module.

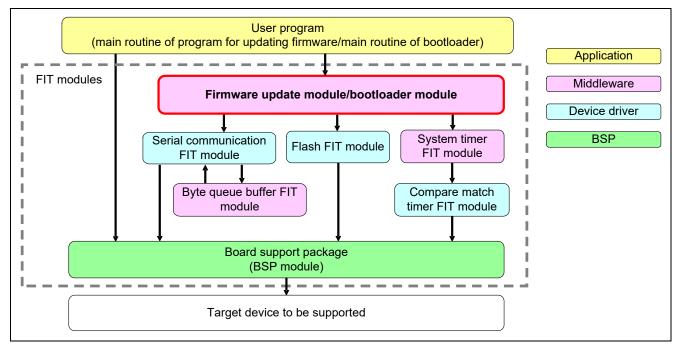


Figure 1.1 System Configuration of Firmware Update Module on OS-less System

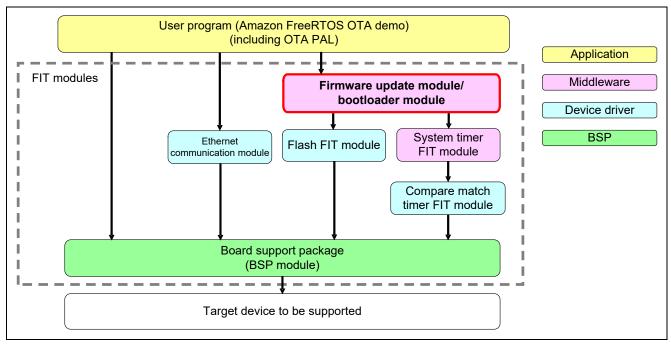


Figure 1.2 System Configuration of Firmware Update Module on System Using FreeRTOS Over-the-Air (OTA) Updates

Table 1.1 List of Modules

Туре	Application Note (Document No.)	FIT Module
BSP	RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)	r_bsp
Device driver		
	RX Family SCI Module Using Firmware Integration Technology (R01AN1815)	
	RX Family CMT Module Using Firmware Integration Technology (R01AN1856)	r_cmt_rx
Middleware	RX Family BYTEQ Module Using Firmware Integration Technology (R01AN1683)	r_byteq
	RX Family System Timer Module Firmware Integration Technology (R20AN0431)	r_sys_time_rx

1.3 Firmware Update Operation

On some products in the RX Family the MCU's on-chip flash memory supports dual-bank functionality.

To program the flash memory on a product without dual-bank functionality or when using a product with dual-bank functionality in linear mode, it is necessary first to copy to the RAM the program that will program the flash memory and then to execute flash memory programming commands from the RAM.

When using a product with dual-bank functionality in dual mode, so long as the area of flash memory to be programmed and the area from which the program performing the programming runs are different areas, it is not necessary to run the program from the RAM. This makes it a simple matter to maintain system operation while programming the flash memory.

The firmware update module is capable of applying firmware updates in both linear mode and dual mode.

Table 1.2 Linear Mode and Dual Mode Support on Specific Devices

Device	Linear Mode	Dual Mode
RX130 Group	0	_
RX140 Group	0	_
RX231 Group	0	_
RX65N Group	0	0
RX66T Group	0	_
RX660 Group	0	_
RX671 Group	0	0
RX72N Group	0	0

1.3.1 Firmware Update Operation Using Dual Mode

Firmware update operation when using the flash memory in dual mode is described below.

Firmware update operation is divided into two parts: initial settings to the on-chip flash memory to prepare for the firmware update and applying the firmware update.

Figure 1.3 shows the initial settings for firmware update operation in dual mode.

A tool (Renesas Image Generator) for creating the initial firmware to be written to the on-chip flash memory is provided together with the FIT module. This tool can be used to create initial firmware containing the user program only or to create initial firmware containing both the bootloader and the user program. By using Flash Programmer or the like to program initial firmware containing both the bootloader and the user program to the on-chip flash memory, the state shown in Figure 1.3 step [4] can be achieved. (Data is programmed to the bootloader (mirror) area in cases where the bootloader is run.)

Alternatively, the state shown in Figure 1.3 step [1] can be achieved by building the bootloader program and programming the resulting .mot file to the on-chip flash memory. If just the bootloader has been programmed to the on-chip flash memory, it is then possible to use the functions of the bootloader to program initial firmware containing only the user program to the on-chip flash memory.

You can start initial settings from step [1] or step [4], depending on the characteristics of the customer's system.

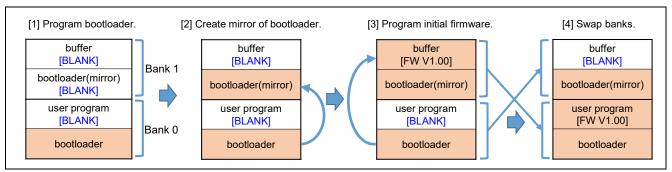


Figure 1.3 Dual Mode Firmware Update Initial Settings

Starting initial settings from step [1]

- [1] Use Flash Programmer or the like to program the bootloader to the on-chip flash memory.
- [2] Run the bootloader to create a mirror of the bootloader in bank 1.
- [3] Use the bootloader to program the initial firmware containing only the user program (must be input externally) and to verify the firmware.
- [4] If the verification completes successfully, swap the banks.

Starting initial settings from step [4]

[4] Use Flash Programmer or the like to program the initial firmware containing the bootloader and the user program to the on-chip flash memory.

Figure 1.4 shows dual mode firmware update operation. (Note that "[1] Initial state" below refers to the state after the bootloader has run at initial startup and a mirror of the bootloader has been created in bank 1.)

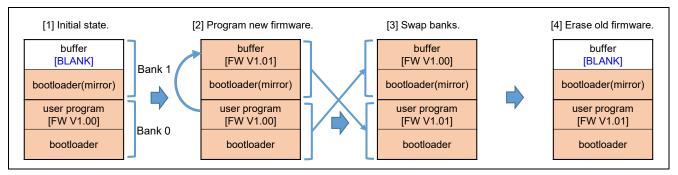


Figure 1.4 Dual Mode Firmware Update Operation

- [1] Initial state.
- [2] Use the firmware update module incorporated in the user program to program the new firmware version (must be input externally) and to verify the firmware after it has been programmed.
- [3] If the verification completes successfully, swap the banks.
- [4] Erase the old firmware from bank 1.

1.3.2 Firmware Update Operation Using Linear Mode

Firmware update operation when using the flash memory in linear mode is described below.

Figure 1.5 shows the initial settings for firmware update operation in linear mode.

A tool (Renesas Image Generator.exe) for creating the initial firmware to be written to the on-chip flash memory is provided together with the FIT module. This tool can be used to create initial firmware containing the user program only or to create initial firmware containing both the bootloader and the user program. By using Flash Programmer or the like to program initial firmware containing both the bootloader and the user program to the on-chip flash memory, the state shown in Figure 1.5 step [2] can be achieved.

Alternatively, the state shown in Figure 1.5 step [1] can be achieved by building the bootloader program and programming the resulting .mot file to the on-chip flash memory. If just the bootloader has been programmed to the on-chip flash memory, it is then possible to use the functions of the bootloader to program initial firmware containing only the user program to the on-chip flash memory.

You can start initial settings from step [1] or step [2], depending on the characteristics of the customer's system.

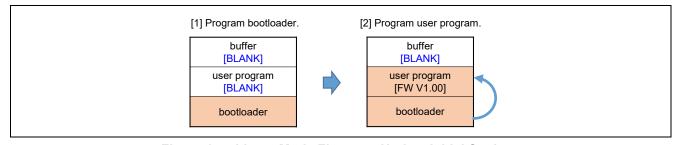


Figure 1.5 Linear Mode Firmware Update Initial Settings

Starting initial settings from step [1]

- [1] Use Flash Programmer or the like to program the bootloader to the on-chip flash memory.
- [2] Use the bootloader to program the initial firmware containing the user program only (must be input externally) and to verify the firmware after it has been programmed to the on-chip flash memory. If the verification completes successfully, the operation is complete.

Starting initial settings from step [2]

[2] Use Flash Programmer or the like to program the initial firmware containing the bootloader and the user program to the on-chip flash memory.

Figure 1.6 shows firmware update operation in linear mode.

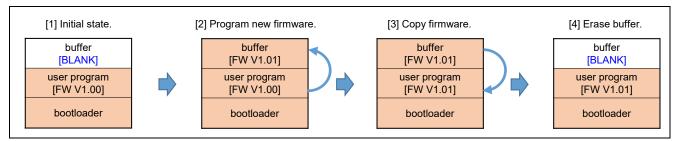


Figure 1.6 Linear Mode Firmware Update Operation

- [1] Initial state.
- [2] Use the user program to program the new firmware version (must be input externally) to the buffer area and to verify the firmware after it has been programmed.
- [3] If the verification completes successfully, copy the firmware from the buffer area to the user program area.
- [4] Erase the buffer area.

1.4 API Overview

Table 1.3 lists the API functions included in the firmware update module.

Table 1.3 API Functions

Function	Function Description	FreeRTOS (OTA) Firmware Update Module	OS-less Firmware Update Module	Bootloader Module
R_FWUP_Open	Performs processing to open the module.	_	0	0
R_FWUP_Close	Performs processing to close the module.	_	0	0
R_FWUP_Operation	Performs firmware update processing from the user program.	_	0	_
R_FWUP_SoftwareReset	Applies a software reset.	_	0	_
R_FWUP_SetEndOfLife	Performs end of life processing for the user program.	0	0	_
R_FWUP_SecureBoot	Performs secure boot processing using the bootloader.	_	_	0
R_FWUP_ExecuteFirmware	Transfers processing to the installed or updated firmware.	_	_	0
R_FWUP_Abort	Stops OTA update processing.	0	_	_
R_FWUP_CreateFileForRx	Applies initial settings for OTA.	0	_	_
R_FWUP_CloseFile	Closes the specified file.	0	_	_
R_FWUP_WriteBlock	Writes a data block to the specified file at the specified offset.	0	_	
R_FWUP_ActivateNewImage	Activates or launches the new firmware image.	0	_	
R_FWUP_ResetDevice	The software resets. Then the new firmware boots via the boot loader.	0	_	
R_FWUP_SetPlatformImageState	Sets the life cycle status to the status specified by an argument.	0	_	
R_FWUP_GetPlatformImageState	Returns the current life cycle status.	0	_	_
R_FWUP_CheckFileSigunature	Checks the signature of the specified file.	0	_	_
R_FWUP_ReadAndAssumeCertificate	Reads and returns the specified signer certificate from the file system.	0		
R_FWUP_GetVersion	Returns the version number of the module.	0	0	0

2. API Information

The FIT module has been confirmed to operate under the following conditions.

2.1 Hardware Requirements

- Flash memory
- · Serial communications interface: optional
- Ethernet: optional
- · System timer module

2.2 Software Requirements

The driver is dependent upon the following FIT module:

- Board support package (r_bsp)
- Byte queue buffer module (r byteq)
- Compare match timer (r cmt rx)
- Flash module (r_flash_rx)
- Serial communications interface (SCI: asynchronous/clock synchronous) (r sci rx): optional
- Ethernet module (r_ether_rx): optional
- System timer module (r_sys_time_rx)

2.3 Supported Toolchain

The driver has been confirmed to work with the toolchain listed in 5.1, Confirmed Operation Environment.

2.4 Header Files

All API calls and their supporting interface definitions are located in r_fwup_if.h.

2.5 Integer Types

The project uses ANSI C99. These types are defined in stdint.h.



2.6 Compile Settings

The configuration option settings of the FIT module are contained in r_fwup_config.h.

The names of the options and descriptions of their setting values are listed in Table 2.1.

Table 2.1 Configuration Settings

Configuration options in r_fwup _c	onfia.h
FWUP_CFG_IMPLEMENTATION	Specifies the user program environment where the FIT module will be
_ENVIRONMENT	implemented.
Note: The default is 0.	The API functions that can be used differ depending on the implementation
	target.
	Enter one of the following setting values.
	0: Implement in bootloader program (default).
	Implement in user program firmware update program (OS-less system).
	2: Implement in FreeRTOS (OTA) program.
	3: Implement in FreeRTOS (OTA) program. 3: Implement in firmware update program using OS other than FreeRTOS.
	5. Implement in himware update program using 03 other than Freet(103).
	More setting values can be added for additional implementation environments.
FWUP_CFG_COMMUNICATION	This configuration setting specifies the communication channel used to obtain
_FUNCTION	the new version of the firmware used by the user program for the firmware
Note: The default is 0.	update.
	Enter one of the following setting values.
	0: Connection via SCI communication (default)
	1: Connection via Ethernet communication
	2: Connection via USB*1
	3: Connection via SDHI*1
	4: Connection via QSPI*1
	More setting values can be added for additional communication channels.
FWUP_CFG_BOOT_PROTECT	Turns boot protection on or off.
_ENABLE	0: Boot protection disabled (default).
Note: The default is 0.	1: Boot protection enabled.*2
FWUP_CFG_OTA_DATA	Specifies the storage destination for FreeRTOS (OTA) data.
_STORAGE	This setting is valid when OTA updating of FreeRTOS is performed. Also,
Note: The default is 0.	ensure that the settings in the boot program and FreeRTOS (OTA) program
	match.
	0: Data flash (default)
	1: Code flash
FWUP_CFG_BOOTLOADER	Suppresses display of character strings by sending printf statements to the
_LOG_DISABLE	terminal software in order to minimize ROM usage.
Note: The default is 0.	This setting is enabled when
	FWUP_CFG_IMPLEMENTATION_ENVIRONMENT is set to "0".
	0: Display character strings in terminal software (default).
	1: Do not display character strings in terminal software.
FWUP_CFG_LOG_LEVEL	Specifies the log output level.
Note: The default is 3.	This setting is valid when FWUP_CFG_IMPLEMENTATION_ENVIRONMENT
	is set to 1.
	0: No log output
	1: Output of error messages only
	2: Output of warnings and error messages
	3: Information, warnings, and error messages (default)
	4: All log output
FWUP_CFG_SERIAL_TERM_SCI	Specifies the SCI channel used to download the firmware.

Configuration options in r_fwup _config.h					
Note: The default is 8.					
FWUP_CFG_SERIAL_TERM_SCI _BITRATE	Specifies the UART baud rate setting used to download the firmware.				
Note: The default is 115,200.					
FWUP_CFG_SERIAL_TERM_SCI _INTERRUPT_PRIORITY	Specifies the SCI interrupt priority level used when downloading the firmware.				
Note: The default is 15.					
FWUP_CFG_SCI_RECEIVE_WAIT	Specifies the UART receive wait time after transmit ends (RTS set to HIGH).				
Note: The default is 300.	The setting unit is microseconds.				
FWUP_CFG_PORT_SYMBOL	Specifies the port symbol of the I/O port used for RTS, the UART receive				
Note: The default is PORTC on the RSK-RX231.	request pin.				
FWUP CFG BIT SYMBOL	Specifies the bit symbol of the I/O port used for RTS, the UART receive request				
Note: The default is B4 on the RSK-RX231.	pin.				

Notes: 1. This item is unsupported, so entering this setting value has no effect.

2. This function prevents the area where the bootloader is stored from being overwritten. Once boot protection is enabled it may not be possible to change the setting back to "boot protection disabled," or to change the accessible area or startup area protection function settings, depending on the environment. Exercise due caution regarding the handling of the boot protection setting.

Some combinations of the configuration option settings FWUP_CFG_IMPLEMENTATION_ENVIRONMENT and FWUP_CFG_COMMUNICATION_FUNCTION are allowed and others are not. The allowed combinations are shown below.

Table 2.2 Allowable Compile Setting Combinations

		FWUP_0	CFG_COM	IMUNICA	TION_FUI	NCTION
		0: SCI	1: Ethernet	2: USB	3: SDHI	4: QSPI
Z'Z 占 ည	0: Bootloader program	0				_
WUP_CF _EMENT, _ENVIRC T	User program firmware update program (OS-less system)	1	_	2		3
CF. NT. NRC	2: FreeRTOS (OTA) program	4	5	6	7	_
G_IM ATIO DNME	3: Firmware update program using OS other than FreeRTOS.	8		9	10	11

Note: In the table above, a numeral represents the setting value of

FWUP_ENV_COMMUNICATION_FUNCTION, and a dash (—) represents an invalid combination of settings.

Not supported except 0, 1, and 5.

The conditions constituting a valid combination of the implementation environment setting and communication channel setting are retained as macros in r_fwup_private.h.

Table 2.3 Valid Combination Macro Values

Macro	Value	Description
FWUP_COMM_SCI_BOOTLOADER	0	Connect a PC (COM port) to the SCI, and perform bootloader processing.
FWUP_COMM_SCI_PRIMITIVE	1	Connect a PC (COM port) to the SCI, and obtain the new version of the firmware via terminal software.
FWUP_COMM_USB_PRIMITIVE	2	Connect a PC (COM port) to the USB, and obtain the new version of the firmware via terminal software.
FWUP_COMM_QSPI_PRIMITIVE	3	Connect an external storage device (an SD card) to the QSPI, and obtain the new version of the firmware.
FWUP_COMM_SCI_AFRTOS	4	Connect a wireless module (SX-ULPGN, BG96, etc.) to the SCI, and obtain the new version of the firmware using FreeRTOS over-the-air (OTA) updates.
FWUP_COMM_ETHER_AFRTOS	5	Connect via Ethernet, and obtain the new version of the firmware using FreeRTOS over-the-air (OTA) updates.
FWUP_COMM_USB_AFRTOS	6	Connect an LTE modem to the USB, and obtain the new version of the firmware using FreeRTOS overthe-air (OTA) updates.
FWUP_COMM_SDHI_AFRTOS	7	Connect a wireless module (Type 1DX, etc.) to the SDHI, and obtain the new version of the firmware using FreeRTOS over-the-air (OTA) updates.
FWUP_COMM_SCI_FS	8	Connect an external storage device (an SD card) to the SCI, and obtain the new version of the firmware using the file system.
FWUP_COMM_USB_FS	9	Connect an external storage device (a USB flash drive) to the USB, and obtain the new version of the firmware using the file system.
FWUP_COMM_SDHI_FS	10	Connect an external storage device (an SD card) to the SDHI, and obtain the new version of the firmware using the file system.
FWUP_COMM_QSPI_FS	11	Connect an external storage device (serial flash memory) to the QSPI, and obtain the new version of the firmware using the file system.

When additional combinations of the implementation environment setting and communication channel setting are added, additional macro settings can be added.

ex.)

0 #define FWUP_COMM_SCI_BOOTLOADER #define FWUP COMM SCI PRIMITIVE #define FWUP_COMM_USB_PRIMITIVE 2 #define FWUP_COMM_QSP_PRIMITIVE 3 #define FWUP COMM SCI AFRTOS #define FWUP_COMM_ETHER_AFRTOS #define FWUP_COMM_USB_AFRTOS #define FWUP COMM SDHI AFRTOS #define FWUP_COMM_SCI_FS 9 #define FWUP_COMM_USB_FS #define FWUP COMM SDHI FS #define FWUP_COMM_QSPI_FS

- // Used for Bootloader with SCI connection from COM port.
- 1 // SCI connection from COM port using primitive R/W.
- 2 // USB connection from COM port using primitive R/W.
- 3 // Connect external storage (SD card) to QSPI using primitive R/W.
- 4 // Connect wireless module to SCI with Amazon FreeRTOS.
- 5 // Connect Eathernet with Amazon FreeRTOS.
- 6 // Connect LTE modem to USB with Amazon FreeRTOS.
- 7 // Connect wireless module to SDHI with Amazon FreeRTOS.
- 8 // External storage (SD card + file system) connected to SCI.
 9 // External storage (USB flash drive + file system) connected to USB.
- 10 // External storage (SD card + file system) connected to SDHI.
- 11 // External storage (Serial flash + file system) connected to QSPI.

2.6.1 Note on Compiling for RX130 and RX140 Environment

To use the FIT module on the RSK RX130 or RX140, change the setting of the board support package (BSP) configuration option for the user stack size (BSP_CFG_USTACK_BYTES) from the default value to 0x1000 (4 KB).

2.7 Code Size

The code sizes associated with the FIT module are listed in the table below.

One representative device is listed for each flash type.*1

Table 2.4 Code Sizes

ROM, RAM, and Stack Code Sizes					
		Memory Used			
		C/C++ Compiler		IAR CC++	
		Package	GCC for	Compiler	
Device	Category	for RX Family	Renesas RX	for RX	Remarks
RX65N	ROM	3,294 bytes	6,889 bytes	3,107 bytes	boot_loader project
(flash type 4)		3,983 bytes	4,329 bytes	3,720 bytes	fwup_main project
		3,050 bytes	4,329 bytes	1,757 bytes	eol_main project
		5,079 bytes	4,595 bytes	_	aws_demos project
	RAM	36,968 bytes	36,957 bytes	36,946 bytes	boot_loader project
		3,217 bytes	3,213 bytes	3,202 bytes	fwup_main project
		2,193 bytes	3,213 bytes	2,178 bytes	eol_main project
		1,252 bytes	1,248 bytes	_	aws_demos project
	Max. stack	1,168 bytes	872 bytes	876 bytes	boot_loader project
	size used	2,192 bytes	2,512 bytes	2,156 bytes	fwup_main project
		800 bytes	2,512 bytes	776 bytes	eol_main project
		1,772 bytes	1,712 bytes	_	aws_demos project
RX231	ROM	3,665 bytes	7,251 bytes	3,340 bytes	boot_loader project
(flash type 1)		3,949 bytes	4,137 bytes	3,616 bytes	fwup_main project
		2,961 bytes	4,137 bytes	1,687 bytes	eol_main project
	RAM	2,961 bytes	6,237 bytes	6,226 bytes	boot_loader project
		3,217 bytes	3,213 bytes	3,202 bytes	fwup_main project
		2,193 bytes	3,213 bytes	2,178 bytes	eol_main project
	Max. stack	1,384 bytes	892 bytes	836 bytes	boot_loader project
	size used	2,172 bytes	2,496 bytes	2,136 bytes	fwup_main project
		772 bytes	2,496 bytes	768 bytes	eol_main project
RX66T	ROM	3,726 bytes	7,268 bytes	3,349 bytes	boot_loader project
(flash type 3)		3,944 bytes	4,134 bytes	3,614 bytes	fwup_main project
		2,792 bytes	4,134 bytes	1,686 bytes	eol_main project
	RAM	36,969 bytes	36,957 bytes	36,946 bytes	boot_loader project
		3,217 bytes	3,213 bytes	3,202 bytes	fwup_main project
		2,189 bytes	3,213 bytes	2,178 bytes	eol_main project
	Max. stack	1,404 bytes	892 bytes	836 bytes	boot_loader project
	size used	2,168 bytes	2,496 bytes	2,136 bytes	fwup_main project
		736 bytes	2,496 bytes	768 bytes	eol_main project

Note: Refer to the application note RX Family Flash Module Using Firmware Integration Technology (R01AN2184) for a detailed description of flash types.

[Conditions]

C/C++ Compiler Package for RX Family

Optimization level: Level 2Link module optimization: Checked

Optimization method:
 Code size optimization

Remove unreferenced variables/functions:
 Unchecked

• FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config): 1

GCC for Renesas RX

Optimization level:
 Optimize size (-Os)

Debug level:

None

• Link options: -WI,--no-gc-sections

• FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config): 1

IAR C/C++ Compiler for RX

Optimization level:

High (Size)

• FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config): 1

Reference: ROM and RAM usage of bootloader

The ROM and RAM usage of the bootloader project on various products is listed below for reference.

Table 2.5 ROM and RAM Usage of Bootloader

ROM and RAM Usage of Bootloader					
		Memory Used			
		C/C++ Compiler	GCC for	IAR C/C++	
Device	Category	Package for RX Family	Renesas RX	Compiler	
RX130	ROM	32,310 bytes	29,540 bytes	25,314 bytes	
	RAM	11,273 bytes	10,972 bytes	14,470 bytes	
RX140	ROM	25,101 bytes	47,340 bytes	21,322 bytes	
	RAM	10,572 bytes	14,204 bytes	17,899 bytes	
RX231	ROM	31,664 bytes	28,384 bytes	24,767 bytes	
	RAM	12,358 bytes	12,076 bytes	15,529 bytes	
RX671	ROM	32.934 bytes	33,084 bytes	30,448 bytes	
	RAM	41,271 bytes	41,044 bytes	45,724 bytes	
RX65N	ROM	33,806 bytes	32,157 bytes	29,744 bytes	
	RAM	41,079 bytes	40,836 bytes	45,708 bytes	
RX66T	ROM	33,009 bytes	30,476 bytes	28,087 bytes	
	RAM	43,524 bytes	43,220 bytes	47,463 bytes	
RX660	ROM	38,963 bytes	50,868 bytes	28,338 bytes	
	RAM	42,979 bytes	45,220 bytes	47,048 bytes	
RX72N	ROM	35,138 bytes	33,337 bytes	30,716 bytes	
	RAM	41,195 bytes	41,144 bytes	45,828 bytes	

[Conditions]

C/C++ Compiler Package for RX Family

Optimization level: Level 2Link module optimization: Checked

Optimization method:
 Code size optimization

Remove unreferenced variables/functions:
 I/O function:
 Unchecked
 Basic version

FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config):

GCC for Renesas RX

Optimization level:
 Optimize size (-Os)

Debug level:

None

• Link options: -WI,--no-gc-sections

• FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config): 1

IAR C/C++ Compiler for RX

Optimization level:

High (Size)

FWUP_CFG_BOOTLOADER_LOG_DISABLE (Config):

2.8 Arguments

Regarding structures used as API function arguments, the file context settings for the Amazon FreeRTOS (OTA) 202002.00 environment are used for other environments as well.

The reused structure is shown below.

Note: Settings that apply to Amazon FreeRTOS when using over-the-air (OTA) updates may change due to version upgrades or the like. You will therefore need to check for any setting changes when applying version upgrades.

Location of declaration in FreeRTOS environment using over-the-air (OTA) updates: aws_demos¥libraries¥ota_for_aws¥source¥include¥ota_private.h

Table 2.6 OTA File Context

```
typedef struct
                                              /*!< @brief Size, in bytes, of the signature. */
   uint16 t size;
  uint8 t data[ kOTA MaxSignatureSize ]; /*!< @brief The binary signature data. */
} Sig256 t;
typedef struct OtaFileContext
   #if defined( WIN32 ) || defined( linux )
                                  /*!< @brief File type is stdio FILE structure after file is open for
     FILE * pFile;
write. */
   #else
     uint8 t * pFile;
                                   / *! < @brief File type is RAM/Flash image pointer after file is open
for write. */
   #endif
   uint32 t fileSize;
                                   /*!< @brief The size of the file in bytes. */
  uint32_t blocksRemaining; /*!< @brief How many blocks remain to be received (a code
optimization). */
   uint32 t fileAttributes;
                                   /*!< @brief Flags specific to the file being received (e.g. secure,
bundle, archive). */
   uint32 t serverFileID;
                                    /*!< @brief The file is referenced by this numeric ID in the OTA
job. */
  uint8 t * pJobName;
                                    /*!< @brief The job name associated with this file from the job
service. */
   uint16_t jobNameMaxSize; /*!< @brief Maximum size of the job name. */</pre>
   uint8 t * pStreamName;
                                   /*!< @brief The stream associated with this file from the OTA
service. */
   uint16_t streamNameMaxSize; /*!< @brief Maximum size of the stream name. */</pre>
                                  /*!< @brief Bitmap of blocks received (for deduplicating and
   uint8 t * pRxBlockBitmap;
missing block request). */
   uint16 t blockBitmapMaxSize; /*!< @brief Maximum size of the block bitmap. */
   uint8 t * pCertFilepath;
                                   /*!< @brief Pathname of the certificate file used to validate the
receive file. */
   uint16 t certFilePathMaxSize; /*!< @brief Maximum certificate path size. */
   \verb|uint16_t| authSchemeMaxSize; / *! < \textit{@brief Maximum size of the auth scheme}. */
   \verb|uint32_t updaterVersion|; /*! < @brief Used by OTA self-test detection, the version of
Firmware that did the update. */
                                   /*!< @brief True if the job is in self test mode. */
   bool isInSelfTest;
   uint8_t * pProtocols; /*!< @brief Authorization scheme. */
```

2.9 Return Values

This section describes return values of API functions. This enumeration is located in r_fwup_if.h as are the prototype declarations of API functions.

Table 2.7 API Return Value Settings

```
typedef enum e fwup err
                                             // Normally terminated.
    FWUP SUCCESS = 0,
                                             // Illegal terminated.
    FWUP FAIL,
    FWUP IN PROGRESS,
                                            // Firmware update is in progress.
    FWUP_END OF LIFE,
                                            // End Of Life process finished.
                                        // End Of Life process finished.
// Firmware Update module is in use by another process.
// R_FWITP Open function is not executed yet.
    FWUP ERR ALREADY OPEN,
                                            // R_FWUP_Open function is not executed yet.
    FWUP ERR NOT OPEN,
    FWUP_ERR_IMAGE_STATE, // Platform image status not suitable for firmware update. FWUP_ERR_LESS_MEMORY, // Out of memory.
    FWUP ERR FLASH,
                                             // Detect error of r_flash module.
                                            // Detect error of communication module.
    FWUP ERR COMM,
    FWUP ERR STATE MONITORING, // Detect error of state monitoring module.
} fwup err t;
```

2.10 Adding the FIT Module to Your Project

The module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e² studio
 By using the Smart Configurator in e² studio, the FIT module is automatically added to your project.
 Refer to "RX Smart Configurator User's Guide: e² studio (R20AN0451)" for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e² studio
 By using the FIT Configurator in e² studio, the FIT module is automatically added to your project. Refer to
 "RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)" for details.
- (3) Adding the FIT module to your project using the FIT Configurator in the IAR Embedded Workbench for Renesas RX environment
 - If you want to add a FIT module in the IAR Embedded Workbench for Renesas RX environment, use the RX Smart Configurator to add the FIT module to your project. Refer to "RX Smart Configurator User's Guide: IAREW (R20AN0535)" for details.

2.11 Note on Status Transition Monitoring Using System Timer

The module uses the system timer to perform status transition monitoring, and the specification stipulates that an error end occurs when more than the specified duration elapses without a status transition. The default value is one minute. Take appropriate measures to ensure that the status does not remain fixed for longer than the specified duration.

3. API Functions

3.1 R_FWUP_Open Function

Table 3.1 R_FWUP_Open Function Specifications

Format	fwup_err_t R_FWUP_Open (void)				
Description	Performs processing to open the firmware update module and bootloader module.				
	Performs processing to open the resources used by the firmware update module and				
	bootloader module, makes OS initial se	ettings (when using an OS), and initializes variables.			
Parameters	None				
Return	FWUP_SUCCESS	: Normal end			
Values	FWUP_ERR_ALREADY_OPEN	: Already open			
	FWUP_ERR_FLASH	: Flash module error			
	FWUP_ERR_COMM	: Communication module error			
	FWUP_ERR_STATE_MONITORING	: Status transition monitoring module error			
Special	_				
Notes					

3.2 R_FWUP_Close Function

Table 3.2 R_FWUP_Close Function Specifications

Format	fwup_err_t R_FWUP_Close (void)	
Description	Performs processing to close the firmware update module and bootloader module.	
	Performs processing to close the resources used by the firmware update module and	
	bootloader module, and makes OS end settings (when using an OS).	
Parameters	None	
Return	FWUP_SUCCESS : Normal end	
Values	FWUP_ERR_NOT_OPEN : Not open	
Special	_	
Notes		

3.3 R_FWUP_Operation Function

Table 3.3 R_FWUP_Operation Function Specifications

Format	fwup_err_t R_FWUP_Operation (void)		
Description	Performs firmware update processing f	rom the user program.	
	Obtains the firmware data to be applied as an update from the communication channel		
	specified in the configuration settings, programs the flash memory, and performs signature		
	verification.		
		be updated is other than VALID or INITIAL_FIRM_	
	INSTALLING, the firmware cannot be	•	
	FWUP_ERR_IMAGE_STATE is reti		
		OGRESS, a firmware update is currently in progress,	
	so call this function again later.		
		SS, the firmware update is complete. Call the	
		Processing transitions to the new firmware after a	
	software reset is applied.		
		ne firmware update failed. Cancel the error and call	
	this function again.		
Parameters	None		
Return	FWUP_SUCCESS	: Firmware update normal end	
Values	FWUP_FAIL	: Firmware update error occurred	
	FWUP_IN_PROGRESS	: Firmware update in progress	
	FWUP_ERR_NOT_OPEN	: Not open	
	FWUP_ERR_IMAGE_STATE	: Updating not possible in current flash status	
	FWUP_ERR_FLASH	: Flash module error	
	FWUP_ERR_STATE_MONITORING	: Firmware update status has not changed for more	
		than specified duration	
Special			
Notes			

3.4 R_FWUP_SoftwareReset Function

Table 3.4 R_FWUP_SoftwareReset Function Specifications

Format	void R_FWUP_SoftwareReset (void)
Description	Applies a software reset.
Parameters	None
Return	None
Values	
Special	_
Notes	

3.5 R_FWUP_SetEndOfLife Function

Table 3.5 R_FWUP_SetEndOfLife Function Specifications

Format	fwup_err_t R_FWUP_SetEndOfLife (void)	
Description	Performs end of life processing for the user program.	
	[Note]	
	When the status is normal end (FWUP_SUCCESS) after this function is called, end of life	
	(EOL) processing is not yet complete.	
	To finish end of life (EOL) processing after this function runs, it is necessary to call the	
	R_FWUP_SoftwareReset function to apply a software reset (software reset with bank swap	
	in dual bank mode), and to execute the remaining end of life processing using the	
	bootloader.	
Parameters	None	
Return	FWUP_SUCCESS : Normal end	
Values	FWUP_ERR_NOT_OPEN : Not open	
	FWUP_ERR_FLASH : Flash module error	
Special		
Notes		

3.6 R_FWUP_SecureBoot Function

Table 3.6 R_FWUP_SecureBoot Function Specifications

Format	int32_t R_FWUP_SecureBoot (void)			
Description	Performs secure boot processing using the bo	otloader.		
	Performs signature verification to check for tampering before allowing the newly installed			
	firmware to run.			
	update from the communication channel sp	If no firmware is installed, the function obtains the firmware data to be applied as an update from the communication channel specified in the configuration settings, programs the flash memory, and performs signature verification.		
	 If the firmware to be applied as an update is substituted as the startup firmware. 	s specified by the user program, it is		
	 If end of life (EOL) processing is specified to firmware. 	by the user program, this function erases the		
	• If the return value is FWUP_IN_PROGRES call this function again later.	S, a secure boot is currently in progress, so		
	If the return value is FWUP_SUCCESS, the secure boot is complete. Call the R_FWUP_ExecuteFirmware function to transition processing to the newly installed or			
	updated firmware.			
	If the return value is "FWUP_END_OF_LIFE", the processing at the end of life (EOL) of the user program is complete.			
	If the return value is FWUP_FAIL, the secure boot failed. If necessary, cancel the error			
Parameters	and call this function again. None			
Return		ure boot normal end		
Values	_	ure boot fromal end		
Values		ure boot error occurred		
		OF LIFE(EOL) processing completed		
	FWUP ERR NOT OPEN : Not of			
		ware update status has not changed for more		
		specified duration		
Special Notes				

3.7 R_FWUP_ExecuteFirmware Function

Table 3.7 R_FWUP_ExecuteFirmware Function Specifications

Format	void R_FWUP_ExecuteFirmware (void)	
Description	Transfers processing to the installed or updated firmware.	
	[Note]	
	The start address of the firmware to which processing is transferred may differ depending on the MCU family or series.	
	It may be necessary to implement processing to obtain the firmware start address to match the implementation environment.	
	[Example: RX65N]	
	Transfer processing to the address set in macro USER_RESET_VECTOR_ADDRESS.	
Parameters	None	
Return	None	
Values		
Special		
Notes		

3.8 R_FWUP_Abort Function

Table 3.8 R_FWUP_Abort Function Specifications

Format	OtaPalStatus_t R_FWUP_Abort (OTA_FileContext_t * const C)	
Description	Stops OTA update processing.	
Parameters	* C	: File context
Return	OtaPalSuccess	: Normal end
Values	OtaPalFileClose	: File context close error
Special	_	
Notes		

3.9 R_FWUP_CreateFileForRx Function

Table 3.9 R_FWUP_CreateFileForRx Function Specifications

Format	OtaPalStatus_t R_FWUP_CreateFileForRx (OTA_FileContext_t * const C)	
Description	Applies initial settings for OTA.	
	Creates a file to store the received data.	
Parameters	* C	: File context
Return	OtaPalSuccess	: Normal end
Values	OtaPalRxFileCreateFailed	: File creation error
Special	_	
Notes		

3.10 R_FWUP_CloseFile Function

Table 3.10 R_FWUP_CloseFile Function Specifications

Format	OtaPalStatus_t R_FWUP_CloseFile (OTA_FileContext_t * const C)		
Description	Closes the specified file.		
	Performs signature verification on the firmware image downloaded to a buffer area in a		
	temporary area.		
	Writes header information for the buf	fer area in the temporary area.	
Parameters	* C	: File context	
Return	OtaPalSuccess	: Normal end	
Values	OtaPalFileClose	: File close error	
	OtaPalSignatureCheckFailed	: Signature verification error	
Special	_		
Notes			

3.11 R_FWUP_WriteBlock Function

Table 3.11 R_FWUP_WriteBlock Function Specifications

Format	int16_t R_FWUP_WriteBlock (OTA_FileContext_t * const C,		xt_t * const C,
	uint32_t ulOffset,		
		uint8_t * con	st pacData,
		uint32_t ulBl	ockSize)
Description	Writes a data block to t	he specified file at the sp	pecified offset.
	When the operation is	successful, returns the n	umber of bytes written.
Parameters	* C	: File context	
	ulOffset	: Code flash write dest	ination offset
	* pacData	: Write data	
	ulBlockSize	: Write data size	
Return	R_OTA_ERR_QUEUE	_SEND_FAIL (-2)	: Error writing to code flash
Values	Other than above:		: Number of bytes written to code flash
Special	_		
Notes			

3.12 R_FWUP_ActivateNewImage Function

Table 3.12 R_FWUP_ActivateNewImage Function Specifications

Format	OtaPalStatus_t R_FWUP_ActivateNewImage (void)	
Description	Activates or launches the new firmware image.	
	Calls the R_FWUP_ResetDevice() function to apply a software reset.	
Parameters	None	
Return	OtaPalSuccess : Normal end	
Values		
Special	—	
Notes		

3.13 R_FWUP_ResetDevice Function

Table 3.13 R_FWUP_ResetDevice Function Specifications

Format	OtaPalStatus_t R_FWUP_ResetDevice (void)	
Description	Calling this function generates a software reset, after which the new firmware is launched through processing by the bootloader.	
Parameters	None	
Return Values	OtaPalSuccess : Normal end	
Special	Close all open peripheral circuits before calling this function.	
Notes	This function does not return because a software reset occurs.	
	If it returns, the system has not been reset or has an error.	

3.14 R_FWUP_SetPlatformImageState Function

Table 3.14 R_FWUP_SetPlatformImageState Function Specifications

Format	OtaPalStatus_t R_FWUP_SetPlatformImageState (OTA_ImageState_t eState)		
Description	Sets the life cycle status to the status specified by a parameter.		
	When updating to the new firmware finishes, the function erases the buffer area in the temporary area.		
Parameters	eState	: Specified status	
Return	OtaPalSuccess	: Normal end	
Values	OtaPalCommitFailed	: Commit error	
	OtaPalBadImageState	: The state of the specified OTA image is out of range	
Special	_		
Notes			

3.15 R_FWUP_GetPlatformImageState Function

Table 3.15 R_FWUP_GetPlatformImageState Function Specifications

Format	OtaPallmageState_t R_FWUP_GetPlatformImageState (void)		
Description	Returns the current life cycle status.		
Parameters	None		
Return	OtaPallmageStatePendingCommit	: Waiting for update	
Values	OtaPallmageStateValid	: Valid	
	OtaPallmageStateInvalid	: Invalid	
Special	—		
Notes			

3.16 R_FWUP_CheckFileSignature Function

Table 3.16 R_FWUP_CheckFileSignature Function Specifications

Format	OtaPalStatus_t R_FWUP_CheckFileSignature (OTA_FileContext_t * const C)	
Description	Checks the signature of the specified file.	
Parameters	* C : File context	
Return	OtaPalSuccess	: Normal end
Values	OtaPalSignatureCheckFailed	: Signature verification error
	OtaPalBadSignerCert	: The signer certificate was unreadable or was zero in length
Special		
Notes		

3.17 R_FWUP_ReadAndAssumeCertificate Function

Table 3.17 R_FWUP_ReadAndAssumeCertificate Function Specifications

Format	uint8_t * R_FWUP_ReadAndAssumeCertificate (const uint8_t * const pucCertName uint32_t * const ulSignerCertSize)	
Description	Reads and returns the specified signer certificate from the file system.	
Parameters	* pucCertName	: Certificate file name
	* ulSignerCertSize	: Certificate size
Return	Pointer to certificate data	
Values		
Special	_	
Notes		

3.18 R_FWUP_GetVersion Function

Table 3.18 R_FWUP_GetVersion Function Specifications

Format	uint32_t R_FWUP_GetVersion (void)	
Description	Returns the version number of the FIT module.	
Parameters	None	
Return	Version number	
Values		
Special	_	
Notes		

4. Demo Project

The demo project includes a main() function that utilizes the FIT module and its dependent modules. The FIT module includes the following demo project.

4.1 Demo project list

The demo projects included in this package are shown below.

```
Demo project set folder using RSK-RX65N starter kit
                                              Amazon FreeRTOS (OTA), CC-RX version demo project
Amazon FreeRTOS (OTA), GCC version demo project
     amazon-freertos-gcc.zip
     amazon-freertos.zip
   .
+-dua l bank
       +-ccrx
                                         : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
              boot loader.zip
                                              Project of boot loader
                                              Project of EOL processing
              eol main, zip
              fwup_main.zip
                                             Project of Firmware update
                                         : Update firmware demo set folder : for GCC for Renesas RX
        -gcc
              boot_loader_gcc.zip
                                              Project of boot loader
              eol_main_gcc.zip
fwup_main_gcc.zip
                                              Project of EOL processing
                                         : Project of Firmware update
                                          : Update firmware demo set folder : for IAR C/C++ Compiler for RX
              boot_loader_iar.zip
                                         Project of boot loaderProject of EOL process
              eol_main_iar.zip
                                              Project of EOL processing
              fwup_main_iar.zip
                                             Project of Firmware update
 -rx66t-rsk
                                         : Demo project set folder using RSK-RX66T starter kit
  +-non-dualbank2
                                          : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
        -ccrx
              boot loader.zip
                                              Project of boot loader
                                              Project of EOL processing
              eol_main.zip
              fwup_main.zip
                                             Project of Firmware update
                                          : Update firmware demo set folder : for GCC for Renesas RX
       ⊢-gcc
              boot_loader_gcc.zip
                                              Project of boot loader
              eol_main_gcc.zip
                                              Project of EOL processing
                                             Project of Firmware update
              fwup main gcc. zip
                                          : Update firmware demo set folder : for IAR C/C++ Compiler for RX
              boot_loader_iar.zip
                                          : Project of boot loader
                                              Project of EOL processing
              eol_main_iar.zip
                                              Project of Firmware update
              fwup_main_iar.zip
.
+-rx72n-rsk
                                         : Demo project set folder using RSK-RX72N starter kit
   +-dualbank
                                         : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
              boot loader.zip
                                             Project of boot loader
Project of EOL processing
              eol_main.zip
              fwup_main.zip
                                              Project of Firmware update
                                         : Update firmware demo set folder : for GCC for Renesas RX
       +-gcc
              boot_loader_gcc.zip
                                              Project of boot loader
              eol_main_gcc.zip
                                              Project of EOL processing
              fwup_main_gcc.zip
                                             Project of Firmware update
                                          : Update firmware demo set folder : for IAR C/C++ Compiler for RX
              boot_loader_iar.zip
                                             Project of boot loader
                                              Project of EOL processing
              eol main iar.zip
                                             Project of Firmware update
              fwup_main_iar.zip
 -rx130-rsk
                                         : Demo project set folder using RSK-RX130 starter kit
  +-non-dualbank2
                                          : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
        -ccrx
                                             Project of boot loader
Project of EOL processing
              boot_loader.zip
              eol main, zip
              fwup_main.zip
                                              Project of Firmware update
                                          : Update firmware demo set folder : for GCC for Renesas RX
         -gcc
              boot_loader_gcc.zip
                                              Project of boot loader
                                              Project of EOL processing
              eol_main_gcc.zip
              fwup_main_gcc.zip
                                             Project of Firmware update
                                          : Update firmware demo set folder : for IAR C/C++ Compiler for RX
                                              Project of boot loader
Project of EOL processing
              boot_loader_iar.zip
              eol_main_iar.zip
fwup_main_iar.zip
                                              Project of Firmware update
```



```
+-rx140-rsk
                                        : Demo project set folder using RSK-RX140 starter kit
   +-non-dualbank2
                                        : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
             boot loader.zip
                                            Project of boot loader
                                            Project of EOL processing
             eol_main.zip
             fwup_main.zip
                                           Project of Firmware update
                                        : Update firmware demo set folder : for GCC for Renesas RX
       +-gcc
                                            Project of boot loader
             boot_loader_gcc.zip
                                           Project of EOL processing
             eol main gcc.zip
                                       : Project of Firmware update
             fwup_main_gcc.zip
                                        : Update firmware demo set folder : for IAR C/C++ Compiler for RX
      +-iar
                                        : Project of boot loader : Project of EOL process
             boot_loader_iar.zip
             eol_main_iar.zip
                                            Project of EOL processing
             fwup_main_iar.zip
                                        : Project of Firmware update
 -rx231-rsk
                                        : Demo project set folder using RSK-RX231 starter kit
  +-non-dualbank2
                                        : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
             boot_loader.zip
                                            Project of boot loader
                                            Project of EOL processing
             eol main.zip
             fwup_main.zip
                                           Project of Firmware update
       +-gcc
                                        : Update firmware demo set folder : for GCC for Renesas RX
             boot_loader_gcc.zip
                                           Project of boot loader
                                            Project of EOL processing
             eol main gcc.zip
              fwup_main_gcc.zip
                                        : Project of Firmware update
                                        : Update firmware demo set folder : for IAR C/C++ Compiler for RX
      +-iar
             boot_loader_iar.zip
                                            Project of boot loader
                                            Project of EOL processing
             eol_main_iar.zip
              fwup_main_iar.zip
                                        : Project of Firmware update
.
+-rx660-rsk
                                        : Demo project set folder using RSK-RX660 starter kit
  +-dua I bank
                                        : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
      +-ccrx
             boot_loader.zip
                                           Project of boot loader
                                           Project of EOL processing
             eol main, zip
             fwup_main.zip
                                        : Project of Firmware update
      +-gcc
                                        : Update firmware demo set folder : for GCC for Renesas RX
             boot_loader_gcc.zip
eol_main_gcc.zip
                                       : Project of boot loader
: Project of EOL process
                                            Project of EOL processing
             fwup_main_gcc.zip
                                          Project of Firmware update
                                        : Update firmware demo set folder : for IAR C/C++ Compiler for RX
      +-iar
             boot_loader_iar.zip
                                        : Project of boot loader
             eol_main_iar.zip
                                            Project of EOL processing
             fwup_main_iar.zip
                                        : Project of Firmware update
-rx671-rsk
                                        : Demo project set folder using RSK-RX671 starter kit
  +-dua I bank
       +-ccrx
                                        : Update firmware demo set folder : for C/C++ Compiler Package for RX Family
             boot loader.zip
                                            Project of boot loader
Project of EOL processing
             eol main, zip
             fwup_main.zip
                                           Project of Firmware update
                                        : Update firmware demo set folder : for GCC for Renesas RX \,
       +-gcc
             boot_loader_gcc.zip
                                            Project of boot loader
                                            Project of EOL processing
             eol_main_gcc.zip
                                            Project of Firmware update
              fwup_main_gcc.zip
                                        : Update firmware demo set folder : for IAR C/C++ Compiler for RX
      +-iar
             boot_loader_iar.zip
                                            Project of boot loader
                                            Project of EOL processing
             eol_main_iar.zip
             fwup_main_iar.zip
                                            Project of Firmware update
```

Figure 4.1 Demo project

4.2 Firmware Update Using Serial Communications Interface (SCI)

The firmware update demo utilizes the serial communications interface (SCI) of the RX65N, which is mounted on the RSK RX65N starter kit board. Communication with the terminal software takes place via SCI channels configured as a UART.

The firmware update demo uses serial port SCI6, which interfaces with the PMOD1. The PMOD1 connector is connected to a serial converter board.

A PC running terminal software is required for data input and output.

Table 4.1 Device Configuration

No.	Device	Description
1	Development PC	The PC used for development.
2	Evaluation board (Renesas Starter Kit for RX65N)	
3	Host PC (running terminal software such as TeraTerm)	PC running serial communication software that supports XMODEM/SUM transfer protocol (The development PC may also be used for this purpose.)
4	USB serial converter board	Converts the serial I/O signals of the Renesas Starter Kit for RX65N to and from USB serial format and connects to the host PC via a USB cable.
5	USB cable	Implements a USB connection between the USB serial converter board and the host PC.

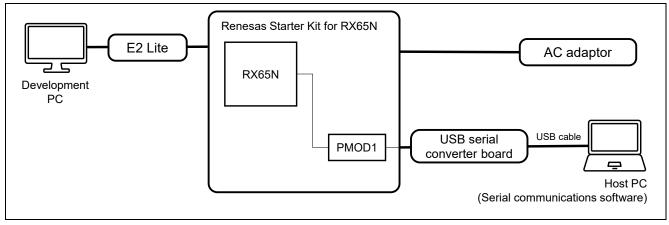


Figure 4.2 RSK RX65N Device Connection Diagram

Table 4.2 Communication Specifications

Item	Description
Communication system	Asynchronous communication
Bit rate	115,200 bps
Data length	8 bits
Parity	None
Stop bit	1 bit
Flow control	None

The following project is used in this firmware update demo.

rx65n-rsk\dualbank\ccrx\

- Boot loader:
 - This program runs first after a reset to verify that the user program has not been tampered with.
- Fwup_main:
 - This program downloads the updated firmware and updates the firmware.
- Eol main:
 - This program EOLs (safely discards) user programs.

4.2.1 Generating the Firmware Update

- 1. To ensure the integrity of the firmware to be applied as an update, the firmware update is digitally signed (ECDSA + SHA256) and the signature is used to verify its integrity. To perform verification, the following code must be added to the boot loader and fwup main and eol main sample application.
 - Adding the Tinycrypt library
 - Public key information setting of Key file used for digital signature

The procedure for adding these items is as follows.

(1) Adding the Tinycrypt library

After obtaining the files from https://github.com/renesas/amazon-freertos/tree/master/libraries/ 3rdparty/tinycrypt, add the lib folder to the src/src/tinycypt/lib folder of the fwup_main_RX65N project.

(2) Public key information setting of Key file

Set the public key information for signature verification in code_signer_public_key.h. Refer to the following link for instructions on setting the information.

https://github.com/renesas/amazon-freertos/wiki/OTA の活用#手順まとめ

- 4. Create the keys to be used for firmware verification in OpenSSL.
- 5. To enable firmware verification using ECDSA + SHA256, import the public key for signature verification (secp256r1.publickey) by the bootloader.



2. Build the **fwup_main_RX65N** sample application and convert the resulting .mot file into an .RSU file. This is the "initial firmware."

The procedure for converting the .mot file into an .RSU file is as follows.

Download Renesas Image Generator.exe from

Release mot file converter tool · renesas/mot-file-converter · GitHub and then run it. (You will also need the other files archived along with it, so download them too.)

- Select the [Initial Firm] tab and set the parameters as shown in the screenshot below.
- Set the path of secp256r1.private key in Private Key Path of Settings.
- Set Bank0 User Program (Binary Format) to Select Output format in Settings.
- For **File Path** under **Bank 0 User Program**, specify the path of the .mot file created as described above.
- Click the [Generate] button to generate an .RSU file, and store it in the init_firmware folder.

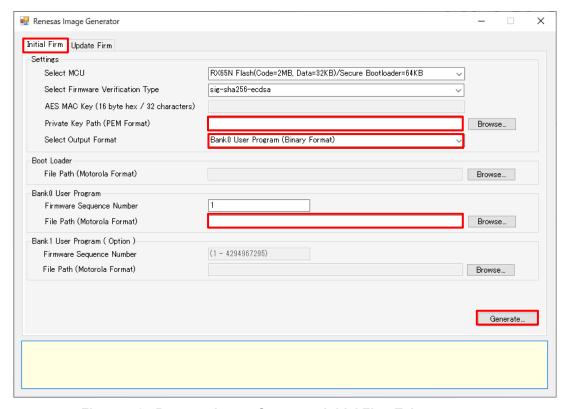


Figure 4.3 Renesas Image Generator Initial Firm Tab

3. Open **src/main.c** and remove the slashes from the left of the commented-out lines to make them valid.

```
Lines 84 to 88 in main.c
// printf("[FWUP_main DEMO] Firmware update demonstration completed.\r\n");
// while(1)
// {
// /* infinity loop */
// }
```

Build the project once again, and convert the resulting .mot file into an .RSU file. This is the "next firmware."

The procedure for converting the .mot file into an .RSU file is as follows.

- Select the [Update Firm] tab and set the parameters as shown in the screenshot below.
- Set the path of secp256r1.private key in **Private Key Path** of **Settings**.
- For **File Path** under **Bank 0 User Program**, specify the path of the .mot file created as described above.
- Click the [Generate] button to generate an .RSU file, and store it in the **update_firmware** folder.

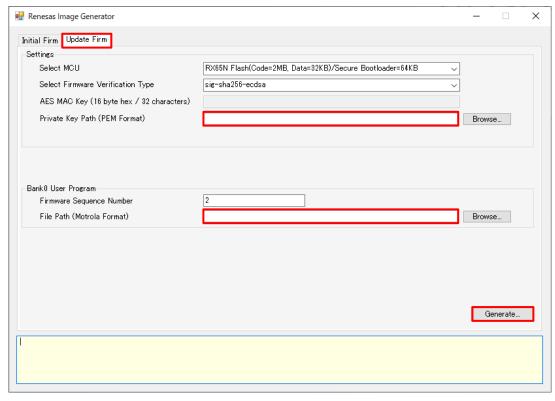


Figure 4.4 Renesas Image Generator Update Firm Tab

4.2.2 Updating the Firmware

- 1. Connect the PC USB port, USB serial converter board, and PMOD1 on the RSK board as shown in Figure 4.1, RSK RX65N Device Connection Diagram.
- 2. Launch the terminal software on the PC. Then select the serial COM port assigned to the USB serial converter board.
- 3. Enter serial communication settings in the terminal software to match the settings of the sample application: 115,200 bps, 8 data bits, no parity, 1 stop bit, no flow control.
- 4. Build the bootloader program, download it to the RSK board, and use the debugger to run the application.
- 5. When you run the software, the following message is output.

```
send "userprog.rsu" via UART.
```

Select the "send file" function in the terminal software, and send the previously created "initial firmware" .RSU file. (Make sure to select the binary transfer option.) The following messages are output while the .RSU file data is being received and written to the code flash.

```
installing firmware...0%(1/960KB).
installing firmware...0%(2/960KB).
installing firmware...0%(3/960KB).
installing firmware...0%(4/960KB).
```

6. When installation and signature verification finish, the application for applying the firmware update is launched, and a message prompting you to input the firmware application is output.

Select the "send file" function in the terminal software, and send the previously created "next firmware" .RSU file. (Make sure to select the binary transfer option.) The following messages are output while the .RSU file data is being received and written to the code flash.

```
[INFO] Flash Write: Address = 0xFFE00000, length = 1024byte ... OK
[INFO] Flash Write: Address = 0xFFE00400, length = 1024byte ... OK
[INFO] Flash Write: Address = 0xFFE00800, length = 1024byte ... OK
[INFO] Flash Write: Address = 0xFFE00C00, length = 1024byte ... OK
```

7. When installation and signature verification of the firmware application finish, execution jumps to the firmware application following a bank swap and other processing.

```
jump to user program
[INFO] Receive file created.
```

8. The firmware application outputs the following message indicating that the demo has completed successfully.

```
[FWUP_main DEMO] Firmware update demonstration completed.
```

4.2.3 Generating EOL Firmware

1. Build the **eol_main** sample application and convert the resulting .mot file into an .RSU file. This is the "eol firmware."

Refer to 4.1.1 above for instructions on converting to .RSU file format.

4.2.4 Firmware EOL

- 1. Connect the PC USB port, USB serial converter board, and PMOD1 on the RSK board as shown in Figure 4.1, RSK RX65N Device Connection Diagram.
- 2. Launch the terminal emulation program (terminal software) on the PC. Then select the serial COM port assigned to the USB serial converter board.
- 3. Enter serial communication settings in the terminal software to match the settings of the sample application: 115,200 bps, 8 data bits, no parity, 1 stop bit, no flow control.
- 4. Build the bootloader program, download it to the RSK board, and use the debugger to run the application.
- 5. When you run the software, the following message is output.

```
send "userprog.rsu" via UART.
```

Select the "send file" function in the terminal software, and send the previously created "eol firmware" .RSU file. (Make sure to select the binary transfer option.) The following messages are output while the .RSU file data is being received and written to the code flash.

```
installing firmware...0%(1/960KB).
installing firmware...0%(2/960KB).
installing firmware...0%(3/960KB).
installing firmware...0%(4/960KB).
```

6. When installation and signature verification finish, the end of life (EOL) application is launched.

```
[INFO] ------
[INFO] End Of Life (EOL) process of user program
[INFO] --------
[INFO] erase install area (code flash):OK
[INFO] update bank1 LIFECYCLE_STATE to [LIFECYCLE_STATE_EOL]
[EOL_main] EOL process completely. Bank swap and software reset.
[INFO] Changing the Startup Bank
[INFO] Resetting the device.
[INFO] Swap bank...
```

7. When the end of life (EOL) application finishes, processing returns to the bootloader, and EOL processing is executed within the bootloader.

```
RX65N secure boot program

Checking flash ROM status.

bank 0 status = 0xe0 [LIFECYCLE_STATE_EOL]

bank 1 status = 0xf8 [LIFECYCLE_STATE_VALID]
```

8. When the following message is output, EOL processing has completed successfully.

```
End Of Life process finished.
```

5. Appendices

5.1 Confirmed Operation Environment

This section describes confirmed operation environment for the FIT module.

Table 5.1 Confirmed Operation Environment (CC-RX)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio 2022 07
C compiler	Renesas Electronics C/C++ Compiler for RX Family V3.04.00
	Compiler option: The following option is added to the default settings of the
	integrated development environment.
	-lang = c99
Endian order	Little endian
Revision of the module	Rev.1.05
Board used	Renesas Starter Kit+ for RX65N (product No.: RTK50565N2SxxxxxBE)
	Renesas Starter Kit for RX660 (product No.: RTK556609HCxxxxxBJ)
	Renesas Starter Kit+ for RX671 (product No.: RTK55671EHS10000BE)
	Renesas Starter Kit+ for RX72N (product No.: RTK5572NNxxxxxxxBE)
USB serial converter	Pmod USBUART (Digilent, Inc.)
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start

Table 5.2 Confirmed Operation Environment (CC-RX)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio 2022 01
C compiler	Renesas Electronics C/C++ Compiler for RX Family V3.04.00
	Compiler option: The following option is added to the default settings of the
	integrated development environment.
	-lang = c99
Endian order	Little endian
Revision of the module	Rev.1.04
Board used	Renesas Starter Kit for RX130-512KB (product No.: RTK5051308SxxxxxBE)
	Renesas Starter Kit for RX140-256KB (product No.: RTK551406BxxxxxBJ)
	Renesas Starter Kit+ for RX231 (product No.: R0K505231SxxxBE)
	Renesas Starter Kit for RX66T (product No.: RTK50566T0S00000BE)
USB serial converter	Pmod USBUART (Digilent, Inc.)
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start

Table 5.3 Confirmed Operation Environment (GCC)

Item	Contents
Integrated development	Renesas Electronics e ² studio 2022 07
environment	
C compiler	GCC for Renesas RX 8.3.0.202102
	Compiler option: The following option is added to the default settings of the
	integrated development environment.
	-std=gnu99
Endian order	Little endian
Revision of the module	Rev.1.05
Board used	Renesas Starter Kit+ for RX65N (product No.: RTK50565N2SxxxxxBE)
	Renesas Starter Kit for RX660 (product No.: RTK556609HCxxxxxBJ)
	Renesas Starter Kit+ for RX671 (product No.: RTK55671EHS10000BE)
	Renesas Starter Kit+ for RX72N (product No.: RTK5572NNxxxxxxxBE)
USB serial converter	Pmod USBUART (Digilent, Inc.)
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start

Table 5.4 Confirmed Operation Environment (GCC)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio 2022 01
C compiler	(For RX140)
	GCC for Renesas RX 8.3.0.202102
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	(Other than RX140)
	GCC for Renesas RX 8.3.0.202004
	Compiler option: The following option is added to the default settings of the integrated development environment.
F 11 1	-std=gnu99
Endian order	Little endian
Revision of the module	Rev.1.04
Board used	Renesas Starter Kit for RX130-512KB (product No.: RTK5051308SxxxxxBE)
	Renesas Starter Kit for RX140-256KB (product No.: RTK551406BxxxxxBJ)
	Renesas Starter Kit+ for RX231 (product No.: R0K505231SxxxBE)
	Renesas Starter Kit for RX66T (product No.: RTK50566T0S00000BE)
USB serial converter	Pmod USBUART (Digilent, Inc.)
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start

Table 5.5 Confirmed Operation Environment (IAR)

Item	Contents
Integrated development	IAR Embedded Workbench for Renesas RX 4.20.3
environment	
C compiler	IAR C/C++ Compiler for Renesas RX 4.20.3
	Compile options: Default settings for the integrated development environment
Smart configurator	RX Smart configurator V2.14.0
Endian order	Little endian
Revision of the module	Rev.1.05
Board used	Renesas Starter Kit+ for RX65N (product No.: RTK50565N2SxxxxxBE)
	Renesas Starter Kit for RX660 (product No.: RTK556609HCxxxxxBJ)
	Renesas Starter Kit+ for RX671 (product No.: RTK55671EHS10000BE)
	Renesas Starter Kit+ for RX72N (product No.: RTK5572NNxxxxxxxBE)
USB serial converter	Pmod USBUART (Digilent, Inc.)
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start

Table 5.6 Confirmed Operation Environment (IAR)

Item	Contents				
Integrated development environment	IAR Embedded Workbench for Renesas RX 4.20.3				
C compiler	IAR C/C++ Compiler for Renesas RX 4.20.3				
	Compile options: Default settings for the integrated development environment				
Smart configurator	RX Smart configurator V2.12.0				
Endian order	Little endian				
Revision of the module	Rev.1.04				
Board used	Renesas Starter Kit for RX130-512KB (product No.: RTK5051308SxxxxxBE)				
	Renesas Starter Kit for RX140-256KB (product No.: RTK551406BxxxxxBJ)				
	Renesas Starter Kit+ for RX231 (product No.: R0K505231SxxxBE)				
	Renesas Starter Kit for RX66T (product No.: RTK50566T0S00000BE)				
USB serial converter	Pmod USBUART (Digilent, Inc.)				
board	https://reference.digilentinc.com/reference/pmod/pmodusbuart/start				

The versions of the FIT modules used by the demo project to confirm firmware update operation are listed below.

(1) Renesas Electronics C/C++ Compiler Package for RX Family

Table 5.7 FIT Module Versions (CC-RX)

				r_flash		r_sys		r_cmt
Device	Project	r_bsp	r_byteq	_rx	r_fwup	_time_rx	r_sci_rx	_rx
RX130	boot_loader	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main							
	eol_main							
RX140	boot_loader	7.00	2.00	4.81	1.04	1.01	4.20	5.00
	fwup_main							
	eol_main							
RX231	boot_loader	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main							
	eol_main							
RX65N	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
	eol_main							
	aws_demos	7.20	2.00	4.90	1.05	1.01	4.40	5.20
->/	boot_loader							
RX66T	boot_loader	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main							
DV000	eol_main	7.00	0.00	4.00	4.05	4.04	4.40	5.00
RX660	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
DVC74	eol_main	7.00	0.00	4.00	4.05	4.04	4.40	5.00
RX671	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
DVZON	eol_main	7.00	2.00	4.00	1.05	1.01	4.40	E 20
RX72N	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
	eol_main							

(2) GCC for Renesas RX

Table 5.8 FIT Module Versions (GCC)

				r_flash		r_sys		
Device	Project	r_bsp	r_byteq	_rx	r_fwup	_time_rx	r_sci_rx	r_cmt_rx
RX130	boot_loader	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main							
	eol_main							
RX140	boot_loader	7.00	2.00	4.81	1.04	1.01	4.20	5.00
	fwup_main							
	eol_main							
RX231	boot_loader	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main							
	eol_main							
RX65N	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
	eol_main_gcc							
	aws_demos	7.00	2.00	4.90	1.05	1.01	4.10	5.00
	boot_loader_gcc							
RX66T	boot_loader_gcc	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main_gcc							
	eol_main_gcc					1		
RX660	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
D)/07/	eol_main	7.00	0.00	4.00	4.05	1.01	4.40	
RX671	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
D)/701:	eol_main_gcc	7.00	0.00	4.00	4.05	4.04	4.40	5.00
RX72N	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
	eol_main_gcc							

(3) IAR C/C++ Compiler for RX

Table 5.9 FIT Module Versions (IAR)

				r_flash		r_sys		
Device	Project	r_bsp	r_byteq	_rx	r_fwup	_time_rx	r_sci_rx	r_cmt_rx
RX130	boot_loader_gcc	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main_gcc							
	eol_main_gcc							
RX140	boot_loader_gcc	7.00	2.00	4.81	1.04	1.01	4.20	5.00
	fwup_main_gcc							
	eol_main_gcc							
RX231	boot_loader_gcc	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main_gcc							
	eol_main_gcc							
RX65N	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
	eol_main_gcc							
RX66T	boot_loader_gcc	7.00	2.00	4.81	1.04	1.01	4.10	5.00
	fwup_main_gcc							
D)/000	eol_main_gcc	7.00	0.00	4.00	4.05	1.01	4.40	
RX660	boot_loader	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main							
D)/074	eol_main	7.00	0.00	4.00	4.05	1.01	4.40	5.00
RX671	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
DVZON	eol_main_gcc	7.00	2.00	4.00	1.05	1.01	4.40	F 20
RX72N	boot_loader_gcc	7.20	2.00	4.90	1.05	1.01	4.40	5.20
	fwup_main_gcc							
	eol_main_gcc							

5.2 Compiler-Dependent Settings

This module supports multiple compilers. To use this module, different settings are required for each compiler as shown below.

5.2.1 Using Renesas Electronics C/C++ Compiler Package for RX Family

This section describes how to use Renesas Electronics C/C++ Compiler Package for RX Family as the compiler. The process of setting up the linker sections must be performed in e² studio.

5.2.1.1 Compiler Options

Add the following option to the default settings of the integrated development environment.

-lang = c99



5.2.1.2 Changing Address Assignments in Flash Memory

The linker section settings need to be changed in order to assign the bootloader and user program to execution areas in the flash memory.

- 1. In the **Project Explorer** view, click the project to be debugged.
- 2. Select **File** → **Properties** to open the **Properties** window.
- 3. In the **Properties** window, select **C/C++ Build** → **Settings**.
- Select the Tool Settings tab, select Linker → Action, and click the [...] button to open the Section Viewer window.

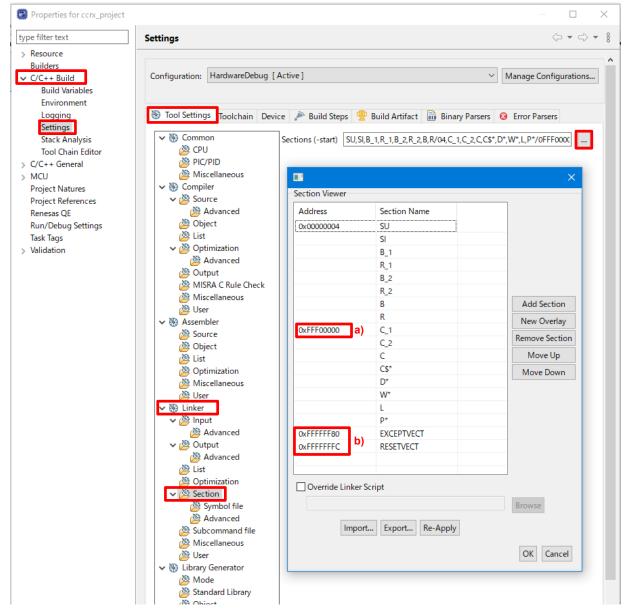


Figure 5.1 Section Settings in Renesas Electronics C/C++ Compiler Package for RX Family

5. Change the values of a) and b) in the **Section Viewer** window to match your environment. Example: The settings are as follows when using the RX65N in dual mode and the bootloader size is 64 KB.

Code	Description	Bootloader Settings	User Program Settings
a)	Start address in flash memory	0xFFFF0000	0xFFF00300
b)	Exception vector and reset vector	0xFFFFFF80	0xFFFEFF80
	addresses	0xFFFFFFC	0xFFFEFFFC

5.2.1.3 Settings for Programming Flash Memory

Settings must be configured in order to write the user program and boot program to flash memory. Refer to the following application note for details of the settings.

Section 5.3.1, Using Renesas Electronics C/C++ Compiler Package for RX Family, in RX Family Flash Module Using Firmware Integration Technology (R01AN2184).

5.2.2 Using GCC for Renesas RX

This section describes how to use GCC for Renesas RX as the compiler. For the linker settings it is necessary to edit the linker settings file generated by e² studio.

5.2.2.1 Compiler Options

- 1. Compiler options: Add the following option to the default settings of the integrated development environment.
 - -std=gnu99
- 2. Link options: When using the **Optimize size (-Os)** option, add the following options to the default settings of the integrated development environment.
 - -WI,--no-gc-sections
 - This is a workaround to prevent the linker from mistakenly discarding interrupt handlers declared in FIT peripheral modules.
- 3. Compiler options: When debugging the bootloader, add the following option to the default settings of the integrated development environment.
 - Optimization level: Optimize for debug (-Og)

5.2.2.2 Changing Address Assignments in Flash Memory

The linker settings need to be changed in order to assign the bootloader and user program to execution areas in the on-chip flash memory.



- 1. In the Project Explorer view, right-click the linker settings file (linker script.ld) and select Open.
- 2. In the linker_script.ld window, click the linker_script.ld tab.

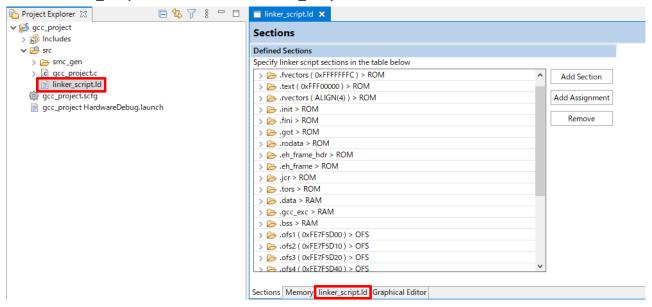


Figure 5.2 Section Settings in GCC for Renesas RX (1/2)

3. Change the values of a) to d) below to match your environment.

```
🔲 linker_script.ld 🛭
  1
      2
  3
            RAM : ORIGIN = 0x4, LENGTH = 0x3fffc
  4
            RAM2 : ORIGIN = 0x008000000. LENGTH = 393216
            ROM : ORIGIN = 0xFFF00000, LENGTH = 1048576
  5
            OFS: ORIGIN = 0xFE7F5D00, LENGTH = 128
  6
  7
       }
  8
      9
        {
 10
            .exvectors 0xFFFFFF80: AT(0xFFFFFF80)
 11
                "_exvectors_start" = .;
 12
 13
                KEEP(*(.exvectors))
            "_exvectors_end" = .;
 14
 15
            } >ROM
            .fvectors 0xFFFFFFFC: AT(0xFFFFFFFC)
 16
 17
 18
                KEEP(*(.fvectors))
            } > ROM
 19
 20
     Θ
            .text 0xFFF00000: AT(0xFFF00000)
 21
            {
                *(.text)
 22
                *(.text.*)
 23
                *(P)
 24
 25
                etext = .;
 26
            } > ROM
  27
     \Theta
            .rvectors ALIGN(4):
 28
            {
```

Figure 5.3 Section Settings in GCC for Renesas RX (2/2)

Example: The settings are as follows when using the RX65N in dual mode and the bootloader size is 64 KB.

Code	Description	Bootloader Settings	User Program Settings
a)	Code flash start address and code	ORIGIN = 0xFFFF0000	ORIGIN = 0xFFF00300
	flash size	LENGTH = 65536	LENGTH = 982272
b)	Exception vector address	0xFFFFFF80	0xFFFEFF80
c)	Reset vector address	0xFFFFFFC	0xFFFEFFFC
d)	Code flash start address = same address as a)	0xFFFF0000	0xFFF00300

5.2.2.3 Settings for Programming Flash Memory

Settings must be configured in order to write the user program and boot program to flash memory. Refer to the following application note for details of the settings.

Section 5.3.2, Using GCC for Renesas RX, in RX Family Flash Module Using Firmware Integration Technology (R01AN2184).

5.2.2.4 Warning Message During Build

When building the FIT module, a warning message may appear indicating that the stack area used by the function exceeds the byte size specified by the -Wstack-usage option ("warning: stack usage is XXX bytes [-Wstack-usage=]"). (The default is 100 bytes.) If there is a problem, make appropriate changes to the build option settings.

5.2.3 Using IAR C/C++ Compiler for RX

This section describes how to use IAR C/C++ Compiler for RX as the compiler.

5.2.3.1 Compiler Options

In the project option settings of IAR Embedded Workbench for Renesas RX, set the output converter \rightarrow output settings to output Motorola S-records.

Change the extension of the output file from the default "* .srec" to "* .mot".

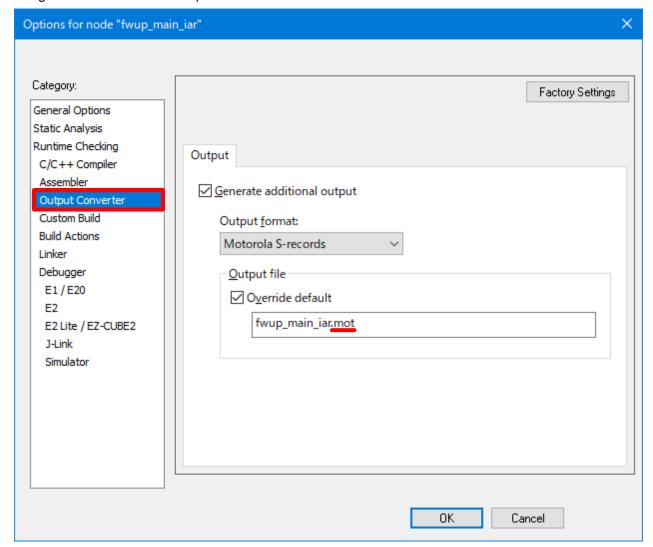


Figure 5.4 Changing the Extension of the Output File

5.2.3.2 Settings for Programming Flash Memory

Settings must be configured in order to write the user program and boot program to flash memory. Refer to the following application note for details of the settings.

Section 5.3.3, Using IAR C/C++ Compiler for Renesas RX, in RX Family Flash Module Using Firmware Integration Technology (R01AN2184).

5.2.3.3 Changing Address Assignments in Flash Memory

The linker settings need to be changed in order to assign the bootloader and user program to execution areas in the on-chip flash memory.

- 1. Open the linker configuration file (* .icf) in an editor.
- 2. Change the following addresses (a) to (c) according to the user's environment. (Example: RX65N boot loader linker configuration file).

```
define region RAM_region1 = mem:[from 0x00000004 to 0x0003FFFF]; define region RAM_region2 = mem:[from 0x00800000 to 0x0085FFFF]; define region RAM_region16 = mem:[from 0x000000004 to 0x00007FFF]; define region RAM_region24 = RAM_region1 | RAM_region2; define region RAM_region32 = RAM_region1 | RAM_region2; define region STANDBY_RAM = mem:[from 0x000A4000 to 0x000A5FFF]; define region ROM_region16 = mem:[from 0xFFFF0000 to 0xFFFFFFFF]; define region ROM_region24 = mem:[from 0xFFFF0000 to 0xFFFFFFFF]; define region ROM_region32 = mem:[from 0xFFFF0000 to 0xFFFFFFFF]; define region DATA_FLASH = mem:[from 0x00100000 to 0x00107FFF]; define region DATA_FLASH = mem:[from 0x00100000 to 0x00107FFFFFFFFF]; define region DATA_FLASH = mem:[from 0x001000000 to 0x00107F
```

The settings are as follows when using the RX65N in dual mode and the bootloader size is 64 KB.

Code	Description	Bootloader Settings	User Program Settings
a)	Code flash start address and code	from 0xFFFF0000	from 0xFFF00300
	flash size	to 0xFFFFFFF	to 0xFFFEFFFF
b)	Reset vector address	0xFFFFFFC	0xFFFEFFFC
c)	Exception vector address	0xFFFFFF80	0xFFFEFF80

5.3 Storage Destination for FreeRTOS Data (RX65N-2MB Only)

You can use a configuration option to select between the code flash and data flash as the storage destination for PKCS11 data (code signing certificate, etc.) used for OTA updating of FreeRTOS. This selection applies to RX65N-2MB products only.

5.3.1 Storage Destination Selection

The following configuration option is used to select the storage destination for PKCS11 data.

Note that this setting is valid when OTA updating of FreeRTOS is performed. Also, ensure that the settings in the boot program and FreeRTOS (OTA) program match.

FWUP_CFG_OTA_DATA_STORAGE

0: Data flash (default)

1: Code flash

The storage area in the data flash is 0x00100000 to 0x00107FFF (32 KB).

The storage area in the code flash is 0xFFE00000 to 0xFFE07FFF (32 KB).

5.3.2 Section Settings

When placing the PKCS11 data in the code flash, configure the section settings of the FreeRTOS (OTA) program as shown in the figure below.

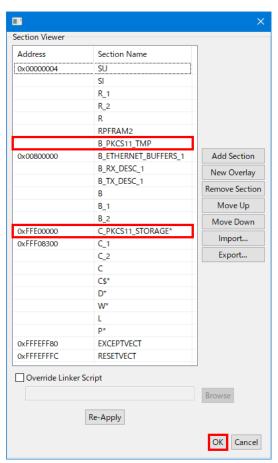


Figure 5.5 Section Settings when Code Flash Selected

When placing the PKCS11 data in the data flash, refer to the section settings in the sample program.

5.3.3 Conversion to .RSU File when Code Flash Selected

The method of converting to an .RSU file when the code flash is selected is described below.

Build the FreeRTOS (OTA) program, then use Renesas Image Generator to convert the resulting .mot file into an .RSU file.

In Renesas Image Generator, select the [Initial Firm] tab and set **Select MCU** to **RX65N Flash(Code=2MB, Data=0KB)**, then convert the file.

Refer to 4.1.1, Generating the Firmware Update, for the file conversion procedure.

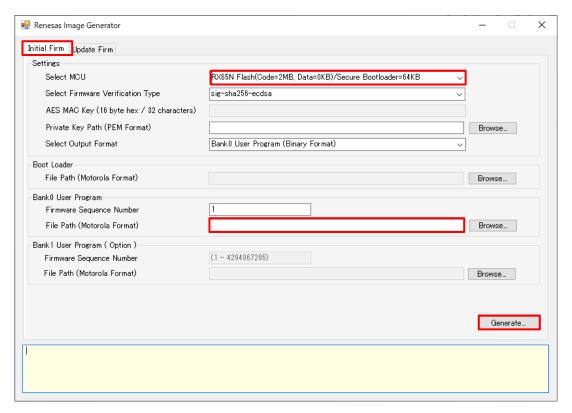


Figure 5.6 Conversion to .RSU File when Code Flash Selected (Initial Firm Tab)

In Renesas Image Generator, select the [Update Firm] tab and set **Select MCU** to **RX65N** Flash(Code=2MB, Data=0KB), then convert the file.

Refer to 4.1.1, Generating the Firmware Update, for the file conversion procedure.

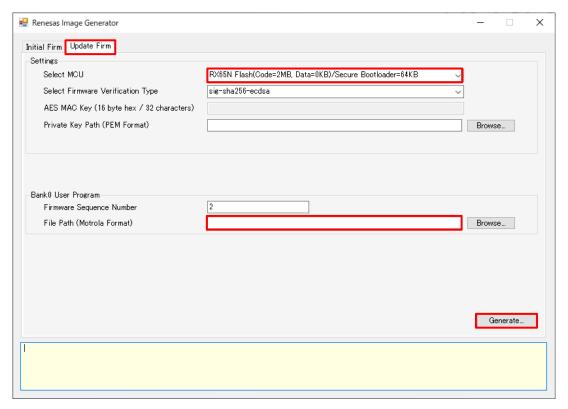


Figure 5.7 Conversion to .RSU File when Code Flash Selected (Update Firm Tab)

Revision History

Rev.	Date	Description	
		Page	Summary
Rev.1.0 5	Apr. 16, 2021		First edition issued
1.01	May 11, 2021	Cover	RX72N Group, RX66T Group, and RX130 Group added to Target Devices
		4	Content of 1. Overview revised
		12	Setting options added to 2.6 Compile Settings
			FWUP_CFG_SERIAL_TERM_SCI
			FWUP_CFG_SERIAL_TERM_SCI_BITRATE
			FWUP_CFG_SERIAL_TERM_SCI_INTERRUPT_PRIORITY Descriptions revised
		15	2.6.1 Note on Compiling for RX130 Environment added
		17	Description of OTA file context added to 2.8 Arguments
			2.12 "for", "while" and "do while" Statements deleted as it no longer applies
		24	Special Notes added to 3.13 R_FWUP_ResetDevice Function
		32	Additions made to Table 5.1 Confirmed Operation Environment (Rev. 1.01)
1.02	Oct. 29, 2021	Cover	RX671 Group added to Target Devices
		6	Description of bootloader module and firmware update module on OS-less system and system using FreeRTOS over-the-air (OTA) updates deleted from 1.2 Configuration of Firmware Update Module
			Connections between serial communication FIT module and byte queue buffer FIT module revised in Figure 1.1
		7	Bootloader module added to Figure 1.2
		8	RX671 Group added to Table 1.2
		9	Explanation added to Figure 1.4
		11	Information in Table 1.3 changed
			Information on bootloader module changed
			Changed to indicate use of R_FWUP_Open and R_FWUP_Close by bootloader module
		17	Code sizes for other than RX65N "boot_loader project" and "aws_demos project" added to GCC for Renesas RX column in 2.7 Code Size
			Code sizes for GCC for Renesas RX added to 2.7 Code Size
		18	Indications of bootloader ROM and RAM usage added
		21	Bootloader module added to description in Table 3.1
			Bootloader module added to description in Table 3.2
		34	Table 5.1 Confirmed Operation Environment revised to Rev. 1.02 in 5.1 Confirmed Operation Environment
		35	Table 5.2 and Table 5.3 listing versions of FIT modules used by the demo project added
			Added versions of FIT modules used by the demo project under GCC on other than the RX65N to Table 5.3
		36	5.2 Compiler-Dependent Settings added
		38	Added optimization level setting when debugging the bootloader to 5.2.2.1 Compiler Options

		Description		
Rev.	Date	Page	Summary	
1.03	Dec. 28, 2021	Cover	Added RX Smart Configurator User's Guide: IAREW to related Application Notes	
			Added IAR C/C++ Compiler for RX to target compiler	
		11	Modify R_FWUP_SoftwareReset in Table 1.3	
			Corrected an error in the function name in Table 1.3	
			Fixed from R_FWUP_ActiveNewImage to	
			R_FWUP_ActivateNewImage	
		13	Added FWUP_CFG_IMPLEMENTATION_ENVIRONMENT setting values in Table 2.1	
		14	Added a note about unsupported combinations that do not work even if set in Table 2.2	
		17	Added code size in IAR C/C++ Compiler for RX environment to Table 2.4	
		18	Added the conditions of IAR C/C++ Compiler for RX when measuring the size in Table 2.4.	
		19	Added the ROM and RAM sizes used by the boot loader in the	
			IAR C/C++ Compiler for RX environment and the conditions for	
			the IAR C/C++ Compiler for RX when measuring the size in Table 2.5.	
		21	Added how to add FIT module in IAR Embedded Workbench for Renesas RX environment to "2.10 Adding the FIT Module to	
			Your Project"	
		22	Fixed the return value of the R_FWUP_Close function	
		23	Fixed the return value of the R_FWUP_Operation function	
		24	Added description of R_FWUP_SetEndOfLife function	
			Fixed the return value of the R_FWUP_SetEndOfLife function	
		25	Added description of R_FWUP_SecureBoot function and return value	
		27	Fixed the return value of the R_FWUP_CloseFile function	
			Corrected an error in the function name	
			Fixed from R_FWUP_ActiveNewImage to	
			R_FWUP_ActivateNewImage	
		28	Fixed the return value of the R_FWUP_SetPlatformImageState function	
		29	Fixed the return value of the R_FWUP_CheckFileSignature function	
		33	Change source image in src / main.c	
		36	Added IAR operation check environment to Table 5.2	
		38	Added a list of FIT module versions to Table 5.5 when checking the operation in the IAR C/C++ Compiler for RX environment	
		43	Added chapter "5.2.3 IAR C/C++ Compiler for RX"	
1.04	May 24, 2022	Cover	Added RX140 Group to Target Devices	
		8	Added RX140 Group to Table 1.2	
		9	Amended description in 1.3.1 Firmware Update Operation Using Dual Mode	
		14, 15	Amended Table 2.1. Deleted FWUP_CFG_USE_SERIAL_FLASH_FOR_BUFFER and FWUP_CFG_SIGNATURE_VERIFICATION. Renamed FWUP_CFG_PRINTF_DISABLE to FWUP_CFG_BOOTLOADER_LOG_DISABLE.	
			Added FWUP_CFG_OTA_DATA_STORAGE and	
			FWUP_CFG_LOG_LEVEL.	

		Description		
Rev.	Date	Page	Summary	
1.04	May 24, 2022	17	Added information on RX140 to description in section 2.6.1	
-		20	Added RX140 ROM and RAM sizes to Table 2.5	
		21	Modified Table 2.6 OTA File Context	
		27	Changed return values of R_FWUP_Abort	
			Changed return values of R_FWUP_CreateFileForRx	
		28	Changed return values of R_FWUP_CloseFile	
			Changed return values of R_FWUP_ActivateNewImage	
		29	Changed return values of R_FWUP_ResetDevice	
			Changed return values of R_FWUP_SetPlatformImageState	
		30	Changed return values of R_FWUP_CheckFileSignature	
		33	Modified Figure 4.2	
		34	Modified Figure 4.3	
		35, 36	Changed log output	
		37, 38	Changed Table 5.1, Table 5.2 and Table 5.3 Confirmed	
			Operation Environment	
		39 to 41	Changed Table 5.4, Table 5.5, and Table 5.6 FIT Module	
			Versions	
		49	Added 5.3 Storage Destination for FreeRTOS Data (RX65N-2MB	
	<u> </u>		Only)	
1.05	Aug 10, 2022	Cover	Added RX660 Group to Target Devices	
		8	Added RX660 Group to Table 1.2	
		12	Added description of R_FWUP_ResetDevice function to Table	
		4.4	1.3	
		14	Added description of FWUP_CFG_BOOTLOADER_LOG_DISABLE function to Table	
			1.3	
		19	Changed build conditions when measuring code size	
		20	Added RX660 ROM/RAM size to Table 1.2	
		20	Changed build conditions when measuring ROM/RAM size used	
			by bootloader	
		23	Deleted FWUP_ERR_LESS_MEMORY and	
			FWUP_ERR_IMAGE_STATE from Return Values of	
			R_FWUP_Open	
		26	Deleted FWUP_ERR_ALREADY_OPEN from Return Value of	
			R_FWUP_SecureBoot and added description of	
			FWUP_ERR_NOT_OPEN	
		29	Added description to Special Notes for R_FWUP_ResetDevice	
		31,32	Added demo project list to Figure 4-1	
		34	Added description of demo program	
		34	4.2.1 (2) Deleted the description of Base64	
		20.44	(3) Deleted the description of the Key file	
		39-41	Added operation check environment for RX660	
		42-44	Added description of RX660 to Table 5-7/5-8/5-9 and updated	
			FIT module version of RX65N, RX671, RX72N	

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

- 1. Precaution against Electrostatic Discharge (ESD)
 - A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
- 2 Processing at power-on
 - The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
- 3. Input of signal during power-off state
 - Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
- 4. Handling of unused pins
 - Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
- 5. Clock signals
 - After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
- 6. Voltage application waveform at input pin
 - Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).
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 - Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not quaranteed.
- 8. Differences between products
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